CHEMTRONICS® Technical Data Sheet

TDS # CTSR

Konform® SR

PRODUCT DESCRIPTION

Konform® SR provides maximum flexibility for extreme temperatures. This transparent coating provides ideal protection for both rigid and flexible printed circuit boards. Cured coatings are hydrolyticly stable and retain their physical electrical properties after high temperature and humidity exposure. Konform® SR will not stress delicate circuit components. Konform® SR resin meets MIL-I-46058C, Type SR.

- Extends component life by protecting against adverse environments
- Good insulation properties, excellent flexibility
- Resists moisture, salt, fungus, corrosive vapors, and severe environments
- Engineered to withstand heat generated by electronic circuitry as well as climatic temperatures
- Contains a UV indicator for Quality Control inspection using medium intensity light at 265-335 nm
- UL Recognized, File E76307

TYPICAL APPLICATIONS

Konform[®] SR is ideal for applications in:

- Aerospace
- Data Communications
- Instrumentation
- Automotive Manufacturing
- Marine Manufacturing
- Process Control

TYPICAL PRODUCT DATA AND PHYSICAL PROPERTIES

| Usable Temp. Range | (-85°F to 390°F) | | | |
|--|---------------------------------------|--|--|--|
| of Cured Coatings | (-65°C to 200°C) | | | |
| Tack Free Time | 15 min. | | | |
| Curing Conditions: Full Cure 24 Hours @ 77°F (25°C) | | | | |
| @ 80% R.H.) or 8 Hours @ 170° (77°C) | | | | |
| | 10 min. @RT followed by 10 min @ 80°C | | | |
| Specific Gravity | 0.74 (Liquid only) | | | |
| (Water=1) @ 68°F | | | | |
| Viscosity (cps @ 77°F) | 40 ± 5 cps | | | |
| Flash Point (TCC) | 60°F | | | |
| Volume Resistivity | 1.5×10^{16} | | | |
| (ohm/cm) | | | | |
| Dielectric Breakdown (volts/mil) 1100 | | | | |
| Thermal Conductivity | 2.9 x 10 ⁻⁴ | | | |
| (Cal-cm/sec-cm ² -°C) | | | | |
| Coefficient of Thermal | 2.1 x 10 ⁻⁴ | | | |
| Expansion (in/in/°C) | | | | |
| Coverage | CTSR-1 250.9 | | | |
| (1 mil/ft ²) | CTSR-12 21.0 | | | |
| Shelflife | 1 year from manufacture | | | |
| Comparative Tracking Index (CTI) 225 V; PLC3 | | | | |

COMPATIBILITY

Konform® SR is generally compatible with most materials found on printed circuit boards. As with any chemical product, product/component compatibility must be determined on a non-critical area prior to use.

Performance Moisture Resistance Excellent Removability Excellent Ease of Repair Excellent Flexibility Excellent Adhesion Excellent Abrasion Resistance Fair Solvent Resistance Good

USAGE INSTRUCTIONS

For industrial use only.

Read MSDS carefully prior to use.

Before applying Konform® SR conformal coatings, clean circuit boards to remove contamination and allow to dry. Cleaning may be performed with Chemtronics® Flux-Off® products.

SPRAY APPLICATION: Apply top to bottom, allowing coating to flow evenly around components. Rotate PCB 90° and repeat application. Rotate and apply coating two additional times, then allow board to cure. If additional thickness is desired, apply additional coatings. When using liquid spray with automatic dispensing equipment, adjustments may be required in application rate and viscosity.

DIP APPLICATION: Using automatic equipment or hand immersion technique, slowly immerse PCB into the coating and remove slowly. Use an average rate of approximately 1 foot per minute. After allowing the board to cure, process may be repeated to achieve desired thickness.

BRUSH APPLICATIONS: Evenly apply coating to areas desired at thickness required. Allow time for curing before reapplying to achieve a thick coating. Use Chemask® to protect components during conformal coating process. After application, cured Konform® SR may be removed by soaking in Chemtronics® Electro-Wash® Two Step.

AVAILABILITY

CTSR-12 10 oz. Aerosol CTSR1 1 Gallon Liquid CTSR5 5 Gallon Liquid

ENVIRONMENTAL IMPACT DATA

(For Aerosol Product)

| ENVIRONMENTAL IMPACT DATA | | | | |
|---------------------------|------|-----|-------|--|
| CFC | 0.0% | VOC | 88.0% | |
| HCFC | 0.0% | HFC | 0.0% | |
| Cl. Solv. | 0.0% | ODP | 0.00 | |

CFC, HCFC, CL. SOLV., VOC, and HFC numbers shown are the content by weight. Ozone depletion potential (ODP) is determined in accordance with the Montreal Protocol and U.S. Clean Air Act of 1990. The ODP of this product is 0.0. It is the sum of the ODP of the substances that may contribute to the depletion of stratospheric ozone, based upon the weight of each substance in the product's formulation.

TECHNICAL & APPLICATION ASSISTANCE

Chemtronics[®] provides a technical hotline to answer your technical and application related questions. The toll free number is: **1-800-TECH-401.**

NOTE: This information is believed to be accurate. It is intended for professional end users having the skills to evaluate and use the data properly. CHEMTRONICS® does not guarantee the accuracy of the data and assumes no liability in connection with damages incurred while using it.

MANUFACTURED BY:

ITW CHEMTRONICS 8125 COBB CENTER DRIVE KENNESAW, GA 30152 1-770-424-4888 REV. J (11/09)

Chemtronics®, Electro-Wash®, Flux-Off®, Chemask®, and Konform® are registered trademarks of ITW Chemtronics. All rights reserved.

| DISTRIBUTED BY: | |
|------------------------|--|
| | |
| | |
| | |
| | |